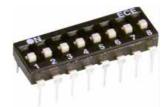


EAM SERIES END-STACKABLE TYPE





FEATURES

- End stackable for standard 0.1" integrated circuit pitch.
- Molded 0.3" integrated circuit packing outline allowing automatic insertion.
- Smaller size makes better heat convection during PC board reflow wave soldering.
- Top tape sealed to withstand wave soldering, board washing.
- All plastics are UL 94V-0 grade fire retardant.
- Twin contacts designed to ensure stable contact.
- Gold plated contact to ensure low contact resistance and Tin plated terminal to prevent contamination during soldering.

SPECIFICATIONS

1.ELECTRICAL

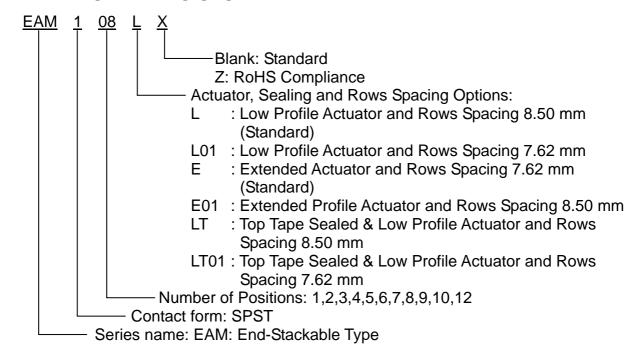
Contact rating			
switching	25mA, 24VDC		
non-switching	100mA		
Contact resistance			
initial	50m Max.		
after life test	100m Max.		
 Insulation resistance 	1000M Min. at 100VDC		
Dielectric strength	500VDC Min. for 60 seconds		
Capacitance between adjacent switches 5pF Max.			



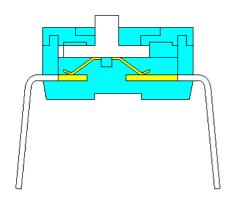
2.MECHANICAL and ENVIRONMENTAL

Temperature rating			
operating	-25 to +70		
storage	-40 to +85		
Operation force	800g Max.		
Mechanical life	2000 operations		
Humidity	95 % RH, 40 for 96 Hrs.		
Vibration	Per MIL-STD-202F, method 204D		
Solderability	after flux 230±5 for 5±0.5 seconds, 95 % coverage		
Resistance to soldering heat	260±5 for 5±1 seconds.		

PART NUMBERING SYSTEM



CONSTRUCTION





OPTIONS

 Special marking and case color available upon request

2. Two kinds of pitch available

Actuator	Pitch(mm)	
	Standard	Option
L	8.50	7.62
E	7.62	8.50

3. Extended Actuator

4. Tape Sealed





DIMENSIONS AND CIRCUITRY

